HALOGEN

FREE



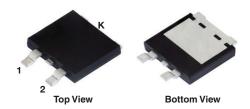
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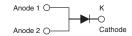
Vishay General Semiconductor

TMBS® (Trench MOS Barrier Schottky) Rectifier for PV Solar Cell Bypass Protection

Ultra Low $V_F = 0.28 \text{ V}$ at $I_F = 5 \text{ A}$

eSMP[®] Series SMPD (TO-263AC)





LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	30 A			
V _{RRM}	45 V			
I _{FSM}	200 A			
V_F at $I_F = 30$ A $(T_A = 125 ^{\circ}C)$	0.51 V			
T _{OP} max. (AC model)	150 °C			
T _J max. (DC forward current)	200 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Single			

FEATURES

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- · Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	V30DL45BP	UNIT		
Maximum repetitive peak reverse voltage	V_{RRM}	45	V		
Maximum DC forward current (fig. 1)	I _{F(DC)} (1)	30	Α		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	200	Α		
Operating junction temperature range (AC model)	T _{OP}	-40 to +150	°C		
Junction temperature in DC forward current without reverse bias, $t = \le 1 \text{ h}$	T _J ⁽²⁾	≤ 200	°C		

Notes

- (1) With heatsink
- (2) Meets the requirements of IEC 61215 ed.2 bypass diode thermal test



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 5 A	T _A = 25 °C	T _A = 25 °C V _F ⁽¹⁾	0.39	-	. V
	I _F = 15 A			0.47	-	
	I _F = 30 A			0.57	0.65	
	I _F = 5 A	T _A = 125 °C		0.28	-	
	I _F = 15 A			0.38	-	
	I _F = 30 A			0.51	0.60	
Reverse current	V _ 45 V	T _A = 25 °C	I _R ⁽²⁾	-	3	- mA
	$V_R = 45 \text{ V}$	T _A = 125 °C		27	70	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	V30DL45BP	UNIT		
Typical thermal resistance	$R_{\theta JC}$	1.1	°C/W	
	R ₀ JA (1)(2)	45	C/VV	

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, without heatsink

ORDERING INFORMATION (Example)					
PACKAGE	KAGE PREFERRED P/N UNIT WEIGHT (g) PACKAGE CODE BASE QUANTITY			DELIVERY MODE	
SMPD (TO-263AC)	V30DL45BP-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

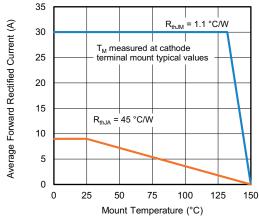


Fig. 1 - Forward Current Derating Curve

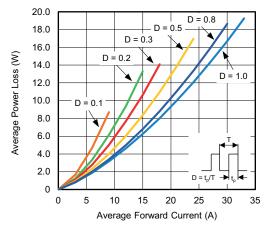


Fig. 2 - Forward Power Loss Characteristics



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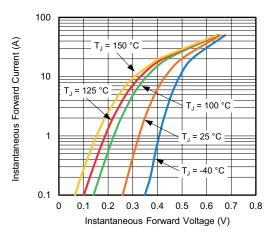


Fig. 3 - Typical Instantaneous Forward Characteristics

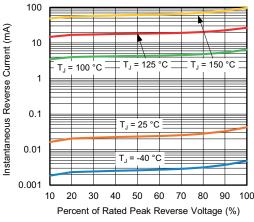


Fig. 4 - Typical Reverse Characteristics

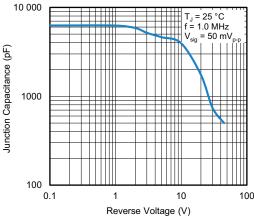


Fig. 5 - Typical Junction Capacitance

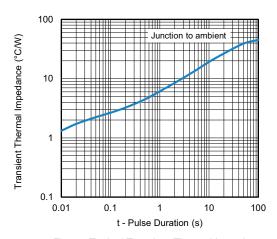


Fig. 6 - Typical Transient Thermal Impedance

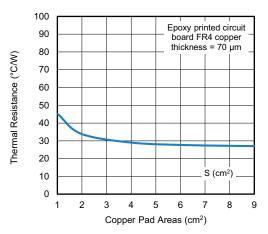
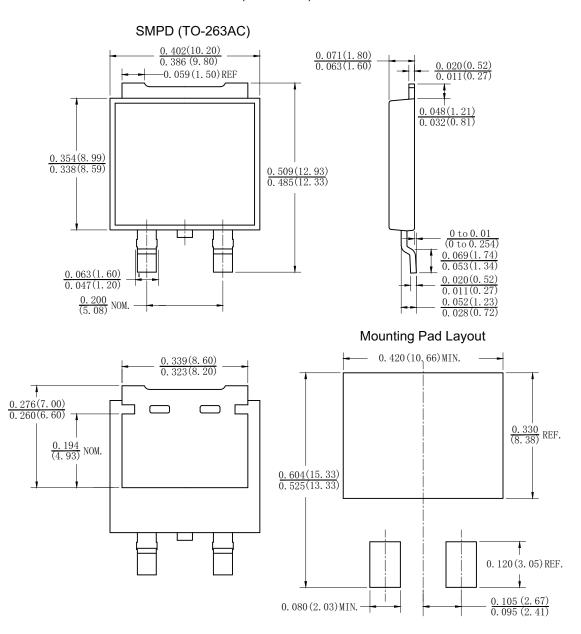


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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